

NTR4501N

Power MOSFET

20 V, 3.2 A, Single N-Channel, SOT-23

Features

- Leading Planar Technology for Low Gate Charge / Fast Switching
- 2.5 V Rated for Low Voltage Gate Drive
- SOT-23 Surface Mount for Small Footprint
- Pb-Free Packages are Available

Applications

- Load/Power Switch for Portables
- Load/Power Switch for Computing
- DC-DC Conversion

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise stated)

| Parameter | | Symbol | Value | Unit | |
|---|------------------------|----------------|--------------------------|------------------|---|
| Drain-to-Source Voltage | | V_{DS} | 20 | V | |
| Gate-to-Source Voltage | | V_{GS} | ± 12 | V | |
| Continuous Drain Current (Note 1) | Steady State | I_D | $T_A = 25^\circ\text{C}$ | 3.2 | A |
| | | | $T_A = 85^\circ\text{C}$ | 2.4 | A |
| Steady State Power Dissipation (Note 1) | Steady State | P_D | 1.25 | W | |
| Pulsed Drain Current | $t_p = 10 \mu\text{s}$ | I_{DM} | 10.0 | A | |
| Operating Junction and Storage Temperature | | T_J, T_{stg} | -55 to 150 | $^\circ\text{C}$ | |
| Continuous Source Current (Body Diode) | | I_S | 1.6 | A | |
| Lead Temperature for Soldering Purposes (1/8" from case for 10 s) | | T_L | 260 | $^\circ\text{C}$ | |

THERMAL RESISTANCE RATINGS

| Parameter | Symbol | Max | Unit |
|------------------------------|-----------------|-----|---------------------------|
| Junction-to-Ambient (Note 1) | $R_{\theta JA}$ | 100 | $^\circ\text{C}/\text{W}$ |
| Junction-to-Ambient (Note 2) | $R_{\theta JA}$ | 300 | |

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

1. Surface-mounted on FR4 board using 1 in sq pad size (Cu area = 1.127 in sq [1 oz] including traces).
2. Surface-mounted on FR4 board using the minimum recommended pad size.

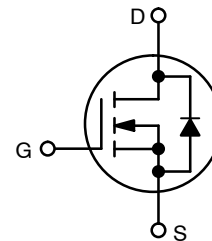


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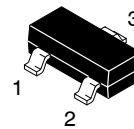
<http://onsemi.com>

| $V_{(BR)DSS}$ | $R_{DS(on)}$ Typ | I_D Max (Note 1) |
|---------------|-----------------------|--------------------|
| 20 V | 70 m Ω @ 4.5 V | 3.6 A |
| | 88 m Ω @ 2.5 V | 3.1 A |

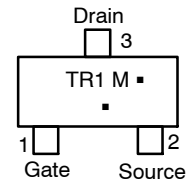
N-Channel



MARKING DIAGRAM & PIN ASSIGNMENT



SOT-23
CASE 318
STYLE 21



TR1 = Device Code
M = Date Code*
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*Date Code orientation and/or overbar may vary depending upon manufacturing location.

ORDERING INFORMATION

| Device | Package | Shipping† |
|-------------|------------------|--------------------|
| NTR4501NT1 | SOT-23 | 3000/Tape & Reel |
| NTR4501NT1G | SOT-23 (Pb-Free) | 3000/Tape & Reel |
| NTR4501NT3 | SOT-23 | 10,000/Tape & Reel |
| NTR4501NT3G | SOT-23 (Pb-Free) | 10,000/Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NTR4501N

Electrical Characteristics (T_J = 25°C unless otherwise specified)

| Parameter | Symbol | Test Condition | Min | Typ | Max | Units |
|---|--------------------------------------|--|-----|------|------|-------|
| OFF CHARACTERISTICS | | | | | | |
| Drain-to-Source Breakdown Voltage (Note 3) | V _{(BR)DSS} | V _{GS} = 0 V, I _D = 250 μA | 20 | 24.5 | | V |
| Drain-to-Source Breakdown Voltage Temperature Coefficient | V _{(BR)DSS} /T _J | | | 22 | | mV/°C |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{GS} = 0 V, T _J = 25°C | | | 1.5 | μA |
| | | V _{DS} = 16 V, T _J = 85°C | | | 10 | μA |
| Gate-to-Source Leakage Current | I _{GSS} | V _{DS} = 0 V, V _{GS} = ±12 V | | | ±100 | nA |

ON CHARACTERISTICS

| | | | | | | |
|--|-------------------------------------|---|------|------|-----|-------|
| Gate Threshold Voltage (Note 3) | V _{GS(TH)} | V _{GS} = V _{DS} , I _D = 250 μA | 0.65 | | 1.2 | V |
| Negative Threshold Temperature Coefficient | V _{GS(TH)} /T _J | | | -2.3 | | mV/°C |
| Drain-to-Source On Resistance | R _{DS(on)} | V _{GS} = 4.5 V, I _D = 3.6 A | | 70 | 80 | mΩ |
| | | V _{GS} = 2.5 V, I _D = 3.1 A | | 88 | 105 | |
| Forward Transconductance | g _{FS} | V _{DS} = 5.0 V, I _D = 3.6 A | | 9 | | S |

CHARGES AND CAPACITANCES

| | | | | | | |
|------------------------------|---------------------|--|--|-----|-----|----|
| Input Capacitance | C _{iss} | V _{GS} = 0 V, f = 1.0 MHz, V _{DS} = 10 V | | 200 | | pF |
| Output Capacitance | C _{oss} | | | 80 | | |
| Reverse Transfer Capacitance | C _{rss} | | | 50 | | |
| Total Gate Charge | Q _{G(TOT)} | V _{GS} = 4.5 V, V _{DS} = 10 V, I _D = 3.6 A | | 2.4 | 6.0 | nC |
| Gate-to-Source Gate Charge | Q _{GS} | | | 0.5 | | |
| Gate-to-Drain Charge | Q _{GD} | | | 0.6 | | |

SWITCHING CHARACTERISTICS (Note 4)

| | | | | | | |
|---------------------|---------------------|--|--|-----|----|----|
| Turn-On Delay Time | t _{d(on)} | V _{GS} = 4.5 V, V _{DS} = 10 V, I _D = 3.6 A, R _G = 6.0 Ω | | 6.5 | 13 | ns |
| Rise Time | t _r | | | 12 | 24 | |
| Turn-Off Delay Time | t _{d(off)} | | | 12 | 24 | |
| Fall Time | t _f | | | 3 | 6 | |

SOURCE-DRAIN DIODE CHARACTERISTICS

| | | | | | | |
|-------------------------|-----------------|---|--|-----|-----|----|
| Forward Diode Voltage | V _{SD} | V _{GS} = 0 V, I _{SD} = 1.6 A | | 0.8 | 1.2 | V |
| Reverse Recovery Time | t _{RR} | V _{GS} = 0 V, dI _S /dt = 100 A/μs, I _S = 1.6 A | | 7.1 | | ns |
| Charge Time | t _a | | | 5 | | |
| Discharge Time | t _b | | | 1.9 | | |
| Reverse Recovery Charge | Q _{RR} | | | 3.0 | | nC |

3. Pulse Test: Pulse width ≤ 300 μs, duty cycle ≤ 2%.

4. Switching characteristics are independent of operating junction temperatures.

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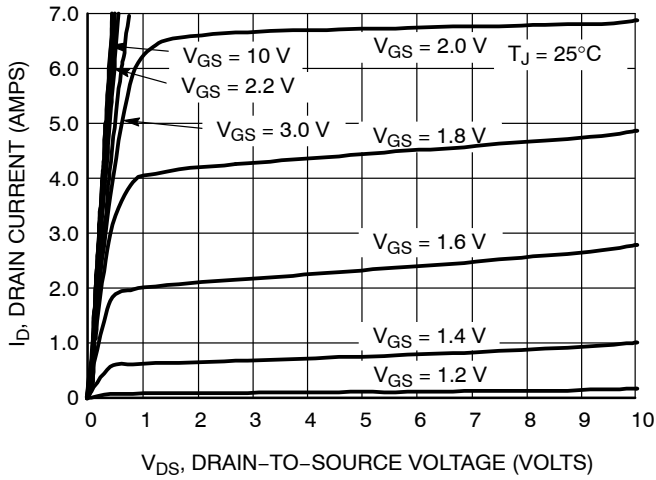


Figure 1. On-Region Characteristics

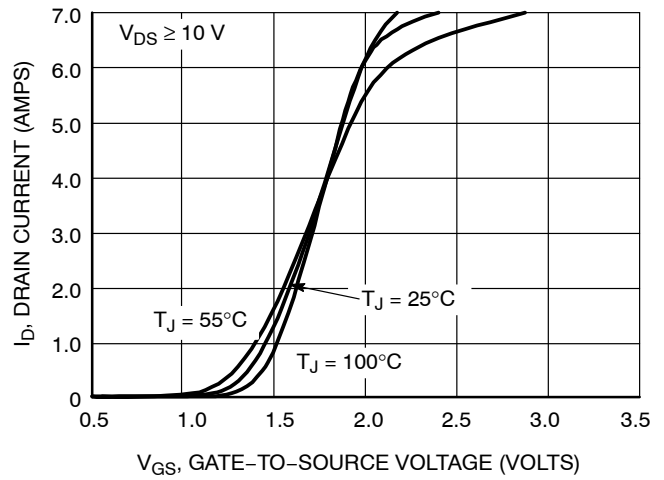


Figure 2. Transfer Characteristics

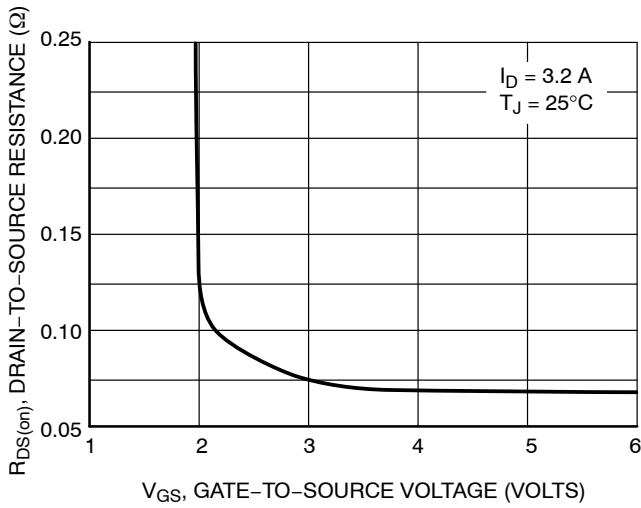


Figure 3. On-Resistance versus Gate-to-Source Voltage

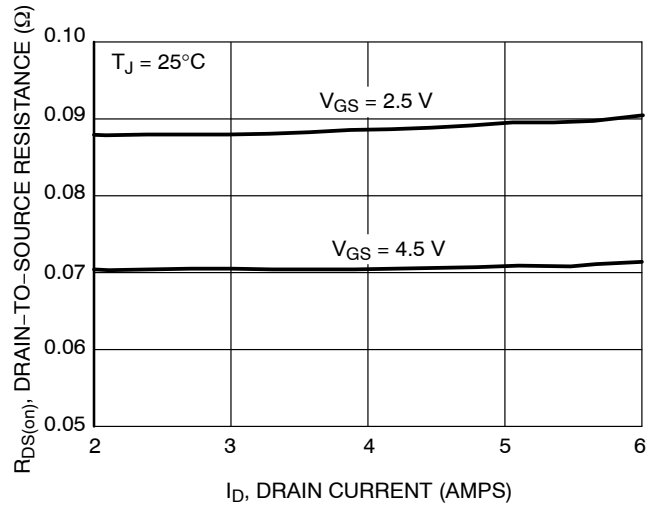


Figure 4. On-Resistance versus Drain Current and Gate Voltage

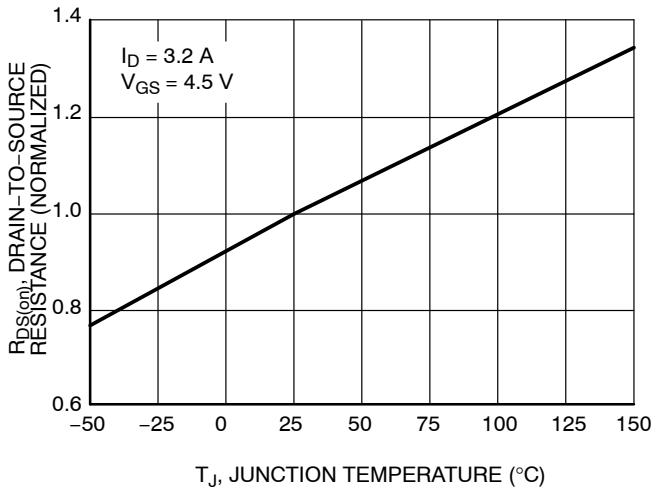


Figure 5. On-Resistance Variation with Temperature

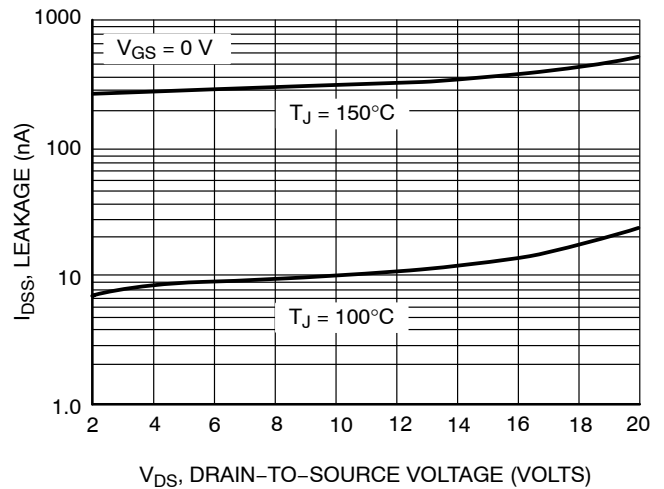


Figure 6. Drain-to-Source Leakage Current versus Voltage

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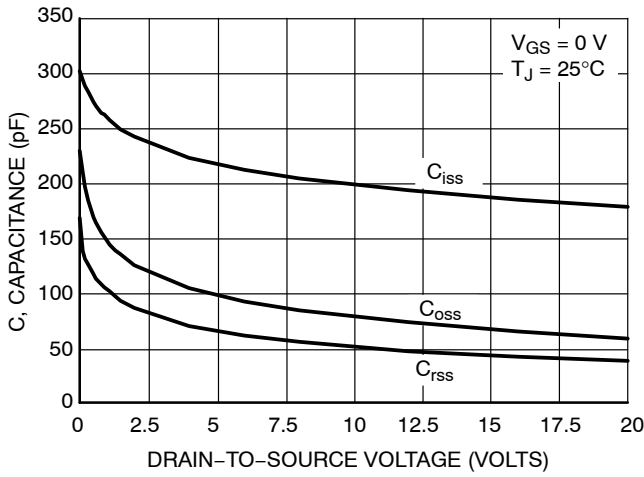


Figure 7. Capacitance Variation

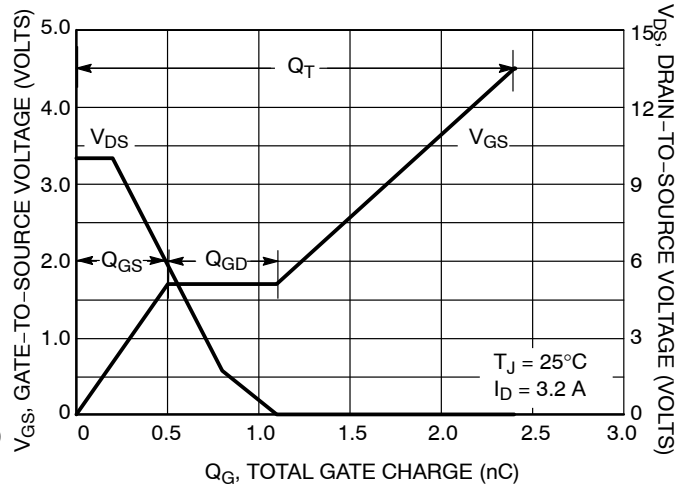


Figure 8. Gate-to-Source and Drain-to-Source Voltage versus Total Charge

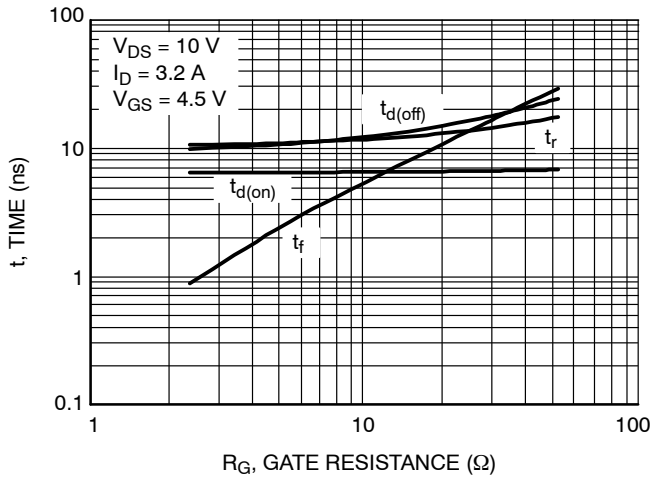


Figure 9. Resistive Switching Time Variation versus Gate Resistance

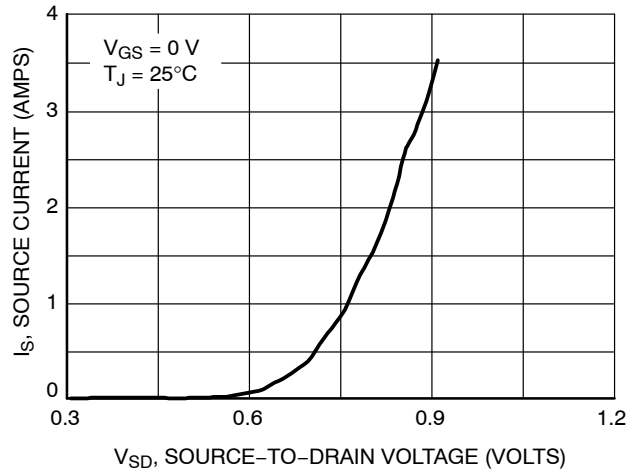
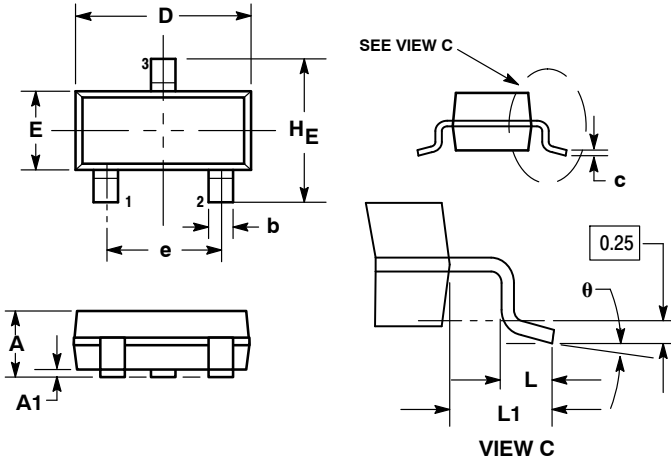


Figure 10. Diode Forward Voltage versus Current

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PACKAGE DIMENSIONS

SOT-23 (TO-236)
CASE 318-08
ISSUE AN

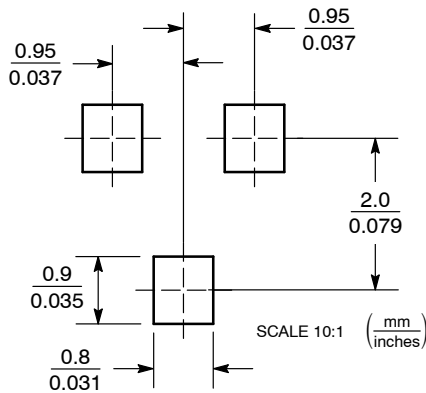


- NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
 4. 318-01 THRU -07 AND -09 OBSOLETE, NEW STANDARD 318-08.

| DIM | MILLIMETERS | | | INCHES | | |
|-----|-------------|------|------|--------|-------|-------|
| | MIN | NOM | MAX | MIN | NOM | MAX |
| A | 0.89 | 1.00 | 1.11 | 0.035 | 0.040 | 0.044 |
| A1 | 0.01 | 0.06 | 0.10 | 0.001 | 0.002 | 0.004 |
| b | 0.37 | 0.44 | 0.50 | 0.015 | 0.018 | 0.020 |
| c | 0.09 | 0.13 | 0.18 | 0.003 | 0.005 | 0.007 |
| D | 2.80 | 2.90 | 3.04 | 0.110 | 0.114 | 0.120 |
| E | 1.20 | 1.30 | 1.40 | 0.047 | 0.051 | 0.055 |
| e | 1.78 | 1.90 | 2.04 | 0.070 | 0.075 | 0.081 |
| L | 0.10 | 0.20 | 0.30 | 0.004 | 0.008 | 0.012 |
| L1 | 0.35 | 0.54 | 0.69 | 0.014 | 0.021 | 0.029 |
| HE | 2.10 | 2.40 | 2.64 | 0.083 | 0.094 | 0.104 |

STYLE 21:
PIN 1. GATE
2. SOURCE
3. DRAIN

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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